- Designed Specifically for High Frequency Electronic Ballasts up to 50 W
- $\mathrm{h}_{\mathrm{FE}} \mathbf{7}$ to 21 at $\mathrm{V}_{\mathrm{CE}}=\mathbf{1} \mathrm{V}, \mathrm{I}_{\mathrm{C}}=\mathbf{8 0 0} \mathrm{mA}$
- Low Power Losses (On-state and Switching)
- Key Parameters Characterised at High Temperature
- Tight and Reproducible Parametric Distributions

TO-220 PACKAGE
(TOP VIEW)
(TOP VIEW)


Pin 2 is in electrical contact with the mounting base.

## absolute maximum ratings at $25^{\circ} \mathrm{C}$ ambient temperature (unless otherwise noted)

| RATING | SYMBOL | VALUE | UNIT |
| :--- | :---: | :---: | :---: |
| Collector-emitter voltage $\left(\mathrm{V}_{\mathrm{BE}}=0\right)$ | $\mathrm{V}_{\mathrm{CES}}$ | 700 | V |
| Collector-base voltage $\left(\mathrm{I}_{\mathrm{E}}=0\right)$ | $\mathrm{V}_{\mathrm{CBO}}$ | 700 |  |
| Collector-emitter voltage $\left(\mathrm{I}_{\mathrm{B}}=0\right)$ | $\mathrm{V}_{\mathrm{CEO}}$ | V |  |
| Emitter-base voltage | $\mathrm{V}_{\mathrm{EBO}}$ | 400 |  |
| Continuous collector current | $\mathrm{I}_{\mathrm{C}}$ | V |  |
| Peak collector current (see Note 1) | $\mathrm{I}_{\mathrm{CM}}$ | 2.5 | V |
| Peak collector current (see Note 2) | $\mathrm{I}_{\mathrm{CM}}$ | A |  |
| Continuous base current | $\mathrm{I}_{\mathrm{B}}$ | 8 | A |
| Peak base current (see Note 2) | $\mathrm{I}_{\mathrm{BM}}$ | 1.5 | 2.5 |
| Continuous device dissipation at (or below) $25^{\circ}{ }^{\circ} \mathrm{C}$ case temperature | $\mathrm{P}_{\text {tot }}$ | A |  |
| Operating junction temperature range | $\mathrm{T}_{\mathrm{j}}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature range | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

NOTES: 1. This value applies for $t_{p}=10 \mathrm{~ms}$, duty cycle $\leq 2 \%$.
2. This value applies for $t_{p}=300 \mu s$, duty cycle $\leq 2 \%$.
electrical characteristics at $25^{\circ} \mathrm{C}$ case temperature (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  |  | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{array}{ll} \mathrm{V}_{\mathrm{CEO}(\text { sus })} & \begin{array}{l} \text { Collector-emitter } \\ \text { sustaining voltage } \end{array} \end{array}$ | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}$ | $\mathrm{L}=25 \mathrm{mH}$ | (see Note 3) | 400 |  |  | V |
| ICESCollector-emitter <br> cut-off current | $\begin{aligned} & \mathrm{V}_{\mathrm{CE}}=700 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CE}}=700 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & V_{B E}=0 \\ & V_{B E}=0 \end{aligned}$ | $\mathrm{T}_{\mathrm{C}}=90^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} 10 \\ 200 \end{gathered}$ | $\mu \mathrm{A}$ |
| $\begin{array}{ll} \hline \mathrm{I}_{\text {EBO }} & \text { Emitter cut-off } \\ \text { current } \end{array}$ | $\mathrm{V}_{\mathrm{EB}}=9 \mathrm{~V}$ | $\mathrm{I}_{\mathrm{C}}=0$ |  |  |  | 1 | mA |
| $V_{B E \text { (sat) }}$ Base-emitter <br> saturation voltage | $\begin{aligned} & I_{B}=160 \mathrm{~mA} \\ & I_{B}=160 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=800 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{C}}=800 \mathrm{~mA} \end{aligned}$ | (see Notes 4 and 5) $\mathrm{T}_{\mathrm{C}}=90^{\circ} \mathrm{C}$ |  | $\begin{aligned} & 0.83 \\ & 0.75 \end{aligned}$ | 0.9 | V |
| $\mathrm{V}_{\mathrm{CE} \text { (sat) }} \quad$Collector-emitter <br> saturation voltage | $\begin{aligned} & I_{B}=160 \mathrm{~mA} \\ & I_{B}=160 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & I_{C}=800 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{C}}=800 \mathrm{~mA} \end{aligned}$ | (see Notes 4 and 5) $\mathrm{T}_{\mathrm{C}}=90^{\circ} \mathrm{C}$ |  | $\begin{aligned} & \hline 0.18 \\ & 0.22 \end{aligned}$ | 0.25 | V |
|  Forward current <br> $h_{\text {FE }}$ <br> transfer ratio | $\begin{array}{ll} \hline \mathrm{V}_{\mathrm{CE}}= & 1 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CE}}= & 1 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CE}}= & 5 \mathrm{~V} \\ \hline \end{array}$ | $\begin{aligned} & I_{C}=10 \mathrm{~mA} \\ & I_{C}=800 \mathrm{~mA} \\ & I_{C}=3.2 \mathrm{~A} \end{aligned}$ |  | $\begin{gathered} \hline 10 \\ 7 \\ 2 \end{gathered}$ | $\begin{gathered} \hline 18.5 \\ 14.5 \\ 7.5 \end{gathered}$ | $\begin{aligned} & 21 \\ & 14 \end{aligned}$ |  |
| $\mathrm{V}_{\text {FCB }} \quad$Collector-base forward <br> bias diode voltage | $\mathrm{I}_{\mathrm{CB}}=60 \mathrm{~mA}$ |  |  |  | 870 |  | mV |

NOTES: 3. Inductive loop switching measurement.
4. These parameters must be measured using pulse techniques, $t_{p}=300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$.
5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts, and located within 3.2 mm from the device body.

## thermal characteristics

|  | PARAMETER | MIN | TYP | MAX |
| :--- | :--- | :---: | :---: | :---: |
| UNIT |  |  |  |  |
| $R_{\theta J A}$ | Junction to free air thermal resistance |  |  | 62.5 |
| ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |  |  |
| $\mathrm{R}_{\theta \mathrm{JC}}$ | Junction to case thermal resistance |  |  | 2.5 |

inductive-load switching characteristics at $25^{\circ} \mathrm{C}$ case temperature

|  | PARAMETER | TEST CONDITIONS |  |  | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {sv }}$ | Storage time | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=800 \mathrm{~mA} \\ & \mathrm{~L}=1 \mathrm{mH} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{B}(\text { on })}=160 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{B}(\text { off })}=320 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & V_{C C}=40 \mathrm{~V} \\ & V_{\mathrm{CLAMP}}=300 \mathrm{~V} \end{aligned}$ |  | 2.5 | 3 | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{fi}}$ | Current fall time |  |  |  |  | 150 | 190 | ns |
| $\mathrm{t}_{\mathrm{xo}}$ | Cross over time |  |  |  |  | 300 | 400 | ns |
| $\mathrm{t}_{\mathrm{sv}}$ | Storage time | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=800 \mathrm{~mA} \\ & \mathrm{~L}=1 \mathrm{mH} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{B}(\text { on })}=160 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{B} \text { (off) })}=100 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=40 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CLAMP}}=300 \mathrm{~V} \end{aligned}$ |  | 4.3 | 5 | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{fi}}$ | Current fall time |  |  |  |  | 140 | 200 | ns |

resistive-load switching characteristics at $25^{\circ} \mathrm{C}$ case temperature

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{sv}}$ | Storage time | $\mathrm{I}_{\mathrm{C}}=800 \mathrm{~mA}$ | $\mathrm{I}_{\mathrm{B}(\mathrm{on})}=160 \mathrm{~mA}$ |  | 2.5 | 3.4 |
| $\mathrm{t}_{\mathrm{fi}}$ | Current fall time | $\mathrm{V}_{\mathrm{Cc}}=300 \mathrm{~V}$ | $\mathrm{I}_{\mathrm{B}(\mathrm{off})}=160 \mathrm{~mA}$ | $\mu \mathrm{~s}$ |  |  |
|  |  |  | 150 | 250 | ns |  |

[^0]
## TYPICAL CHARACTERISTICS



Figure 1.

INDUCTIVE SWITCHING TIMES COLLECTOR CURRENT


Figure 3.

COLLECTOR-EMITTER SATURATION VOLTAGE COLLECTOR CURRENT
 Figure 2.

INDUCTIVE SWITCHING TIMES
vs

CASE TEMPERATURE


Figure 4.

## TYPICAL CHARACTERISTICS



Figure 5.


Figure 7.

INDUCTIVE SWITCHING TIMES
vs
CASE TEMPERATURE


Figure 6.

RESISTIVE SWITCHING TIMES
vs
CASE TEMPERATURE


Figure 8.

[^1]
## MAXIMUM SAFE OPERATING REGIONS



Figure 9.


Figure 10.

## MECHANICAL DATA

## TO-220

3-pin plastic flange-mount package
This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. The centre pin is in electrical contact with the mounting tab.
B. Mounting tab corner profile according to package version.
C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm . Version 2, 17.6 mm .

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